

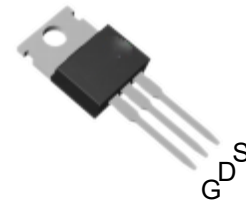
Features

- 60V/200A
 $R_{DS(ON)}=1.5m\Omega(typ.)@V_{GS}=10V$
- 100% UIS + R_g Tested
- Reliable and Rugged
- Lead Free and Green Devices Available
(RoHS Compliant)
- Moisture Sensitivity Level MSL1
(per JEDEC J-STD-020D)

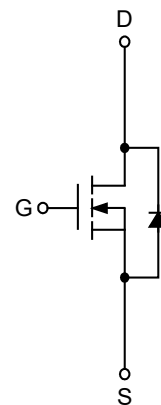
Applications

- High Efficiency Synchronous Rectification in SMPS.
- Uninterruptible Power Supply.
- BLDC Motor drive applications.
- Battery powered circuits.

Pin Description



TO-220



N-Channel MOSFET

Absolute Maximum Ratings (T_A=25°C Unless Otherwise Noted)

Symbol	Parameter		Rating	Unit
Common Ratings				
V _{DSS}	Drain-Source Voltage		60	V
V _{GSS}	Gate-Source Voltage		±25	
T _J	Maximum Junction Temperature		175	°C
T _{STG}	Storage Temperature Range		-55 to 175	
I _S	Diode Continuous Forward Current	T _C =25°C	200	A
I _D	Continuous Drain Current	T _C =25°C	200	
	Continuous Drain Current	T _C =100°C	150	
I _{DM} ^a	Pulsed Drain Current	T _C =25°C	600	
P _D	Maximum Power Dissipation	T _C =25°C	250	W
		T _C =100°C	125	
R _{θJC}	Thermal Resistance-Junction to Case		0.6	°C/W
R _{θJA}	Thermal Resistance-Junction to Ambient		62.5	°C/W
I _{AS} ^b	Avalanche Current, Single pulse	L=0.5mH	90	A
E _{AS} ^b	Avalanche Energy, Single pulse	L=0.5mH	2025	mJ

Note * : Current limited by bonding wire.

Note a : Pulse width limited by maximum junction temperature.

Note b : UIS tested and pulse width limited by maximum junction temperature (initial temperature T_J=25°C).

Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

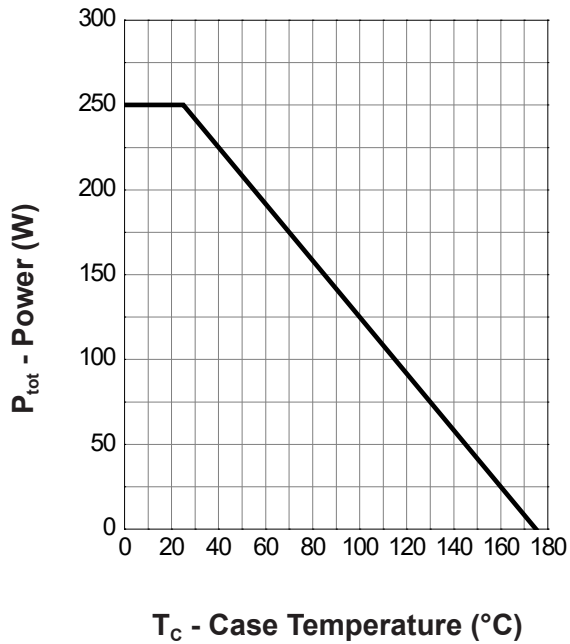
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250μA	60	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =48V, V _{GS} =0V T _J =85°C	-	-	1 30	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250μA	2	3	4	V
I _{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R _{DS(ON)} ^c	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =60A	-	1.5	2.0	mΩ
Diode Characteristics						
V _{SD} ^c	Diode Forward Voltage	I _{SD} =60A, V _{GS} =0V	-	0.85	1.3	V
t _{rr} ^d	Reverse Recovery Time	I _{SD} =60A, dI _{SD} /dt=100A/μs	-	71	-	ns
Q _{rr} ^d	Reverse Recovery Charge		-	103	-	nC
Dynamic Characteristics ^d						
R _G	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=1MHz	-	1.8	-	Ω
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =30V, Frequency=1.0MHz	-	9250	13050	pF
C _{oss}	Output Capacitance		-	1980	-	
C _{rss}	Reverse Transfer Capacitance		-	62	-	
t _{d(ON)}	Turn-on Delay Time	V _{DD} =30V, R _L =30Ω, I _{DS} =1A, V _{GEN} =10V, R _G =6Ω	-	31	55	ns
t _r	Turn-on Rise Time		-	18	32	
t _{d(OFF)}	Turn-off Delay Time		-	100	180	
t _f	Turn-off Fall Time		-	195	350	
Gate Charge Characteristics ^d						
Q _g	Total Gate Charge	V _{DS} =30V, V _{GS} =10V, I _{DS} =60A	-	95	133	nC
Q _{gs}	Gate-Source Charge		-	35	-	
Q _{gd}	Gate-Drain Charge		-	10.3	-	

Note c : Pulse test ; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

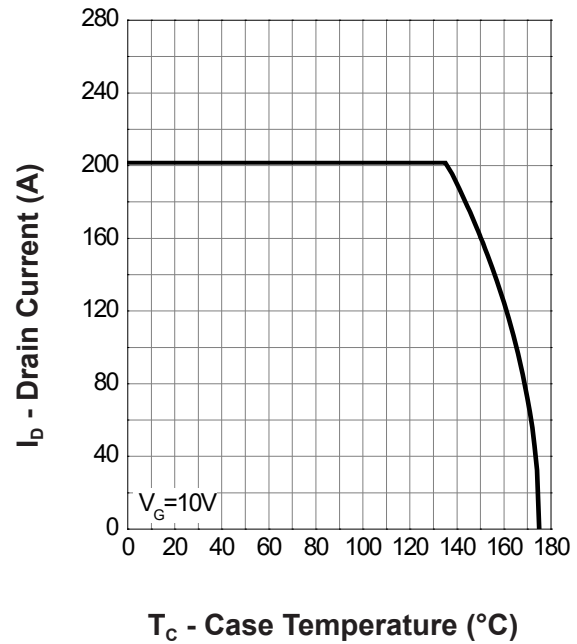
Note d : Guaranteed by design, not subject to production testing.

Typical Operating Characteristics

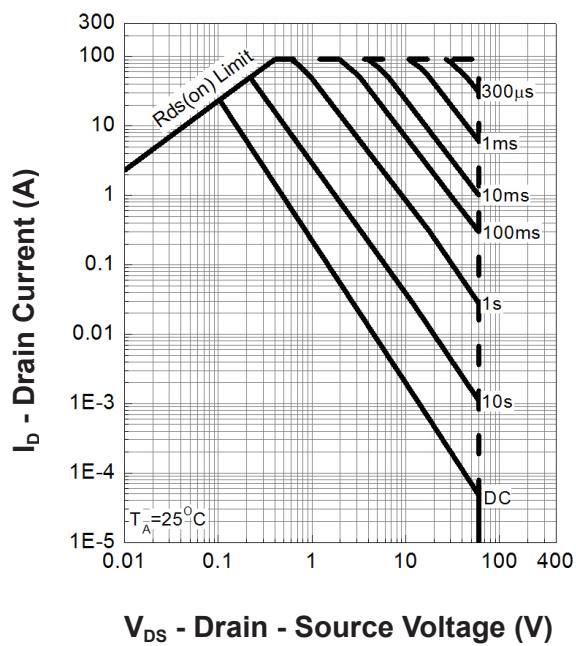
Power Dissipation



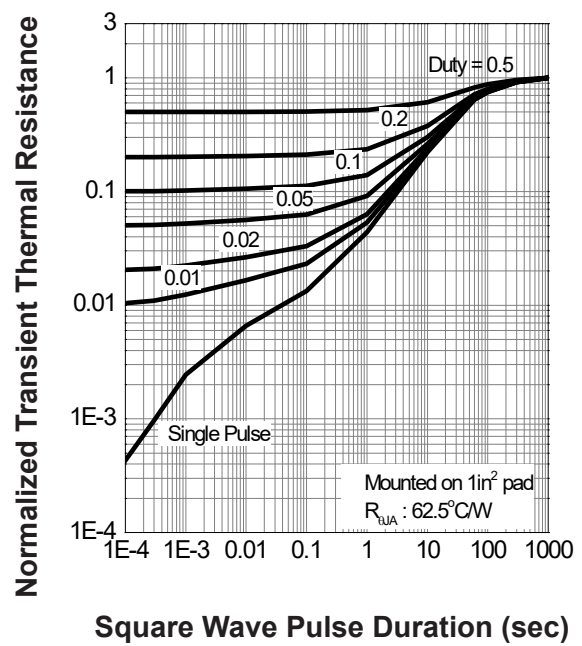
Drain Current



Safe Operation Area

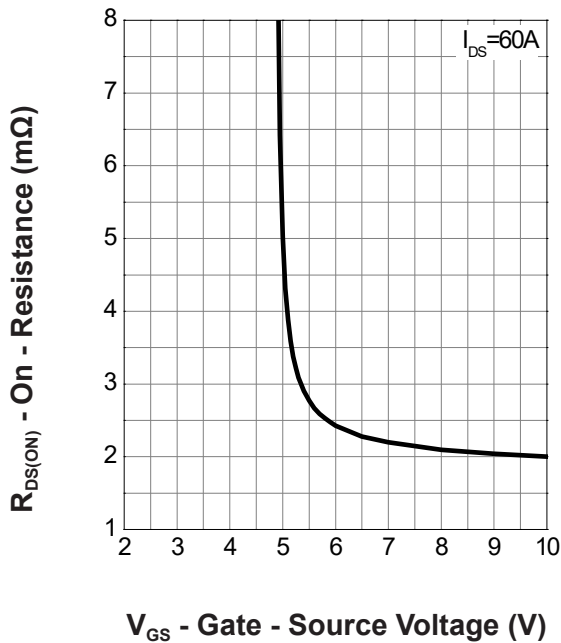


Thermal Transient Impedance

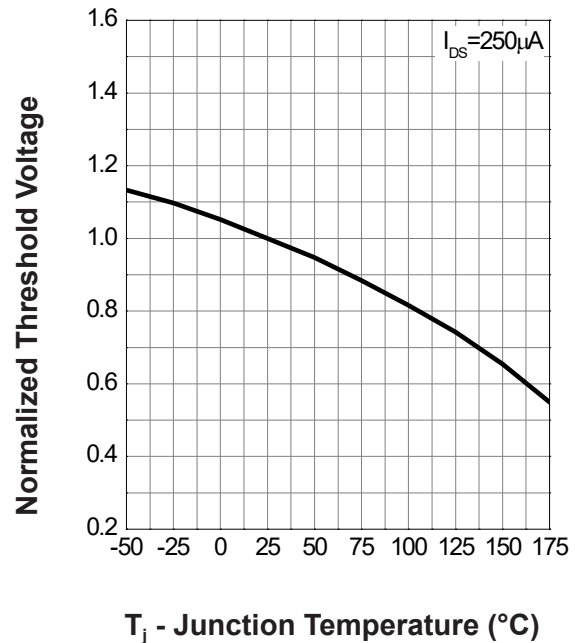


Typical Operating Characteristics(Cont.)

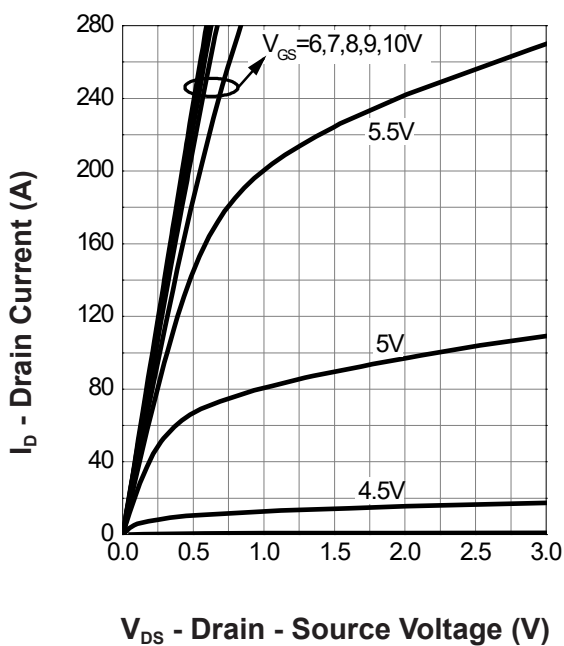
Gate-Source On Resistance



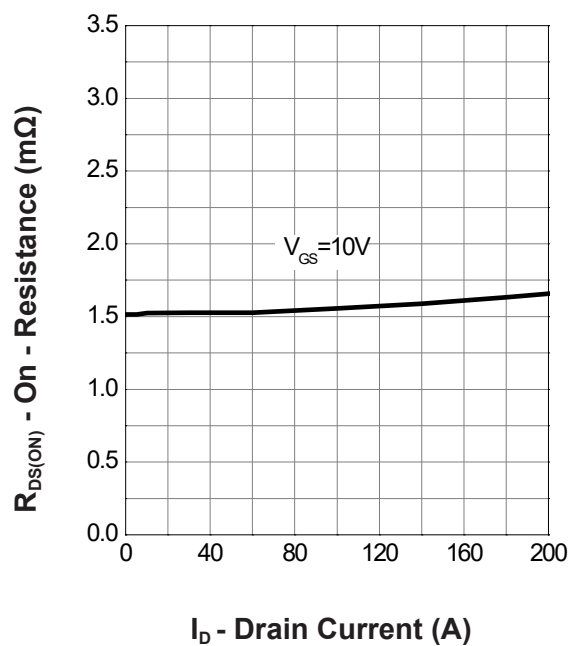
Gate Threshold Voltage



Output Characteristics

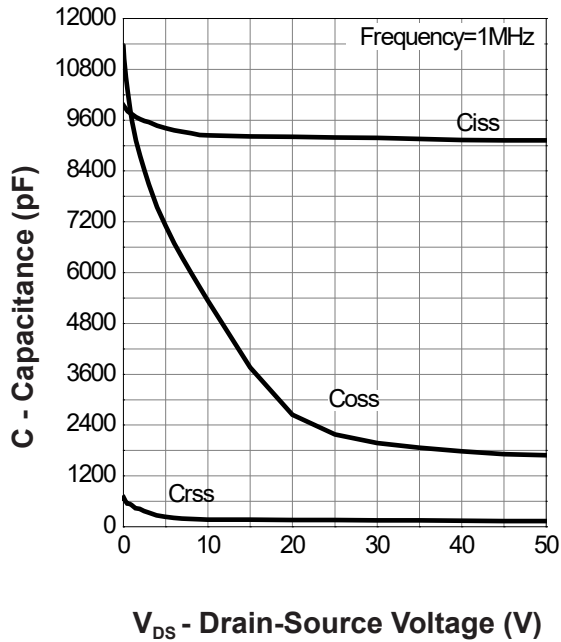


Drain-Source On Resistance

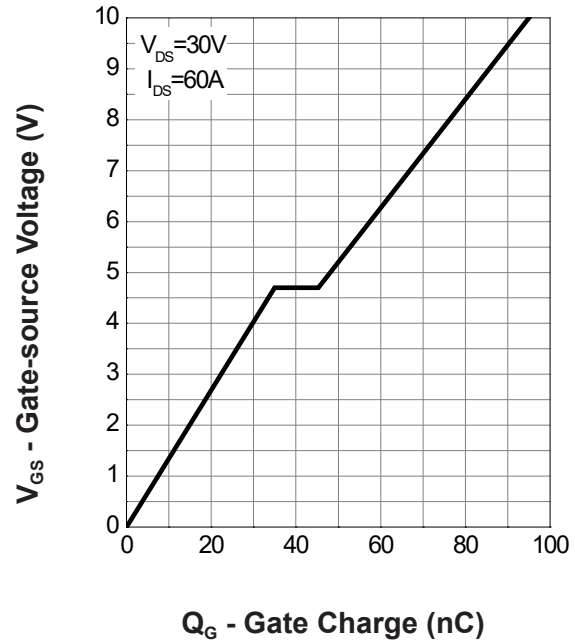


Typical Operating Characteristics(Cont.)

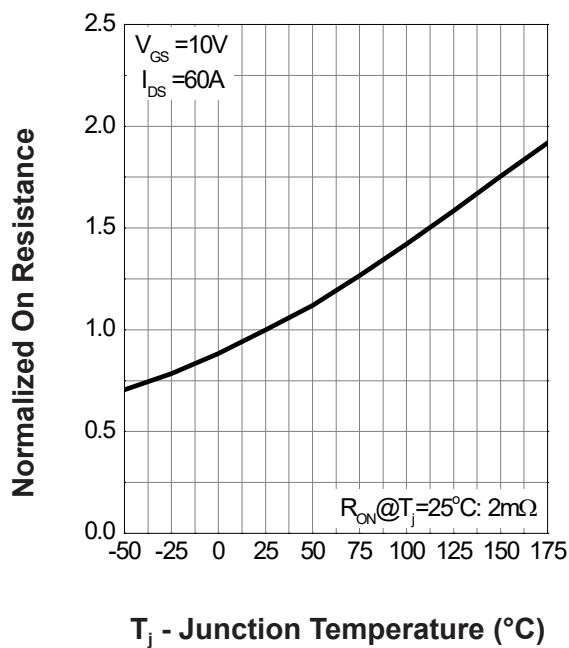
Capacitance



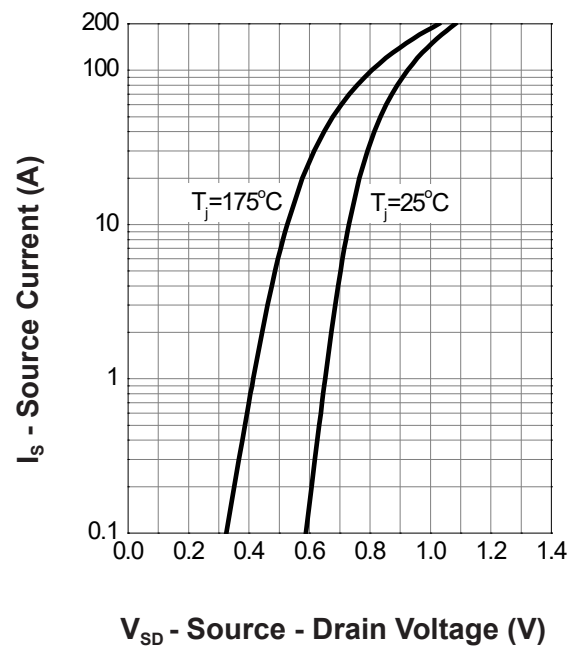
Gate Charge



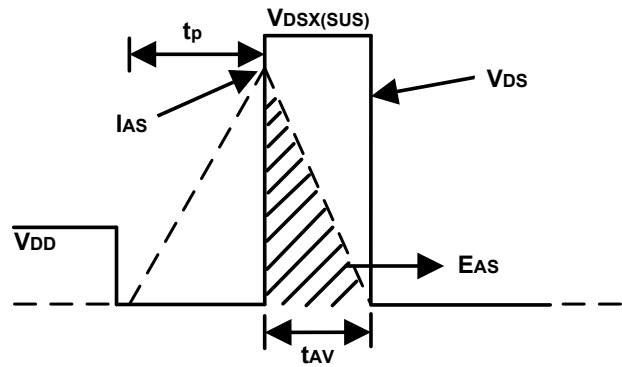
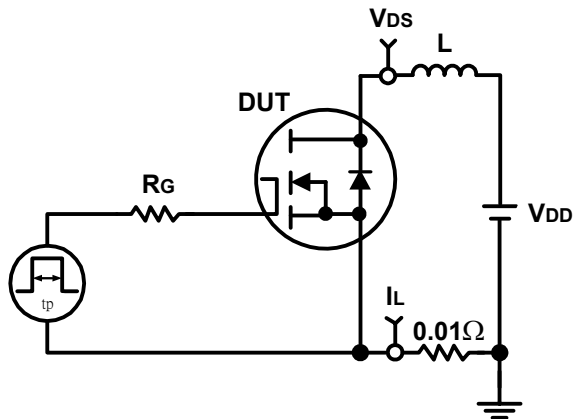
Drain-Source On Resistance



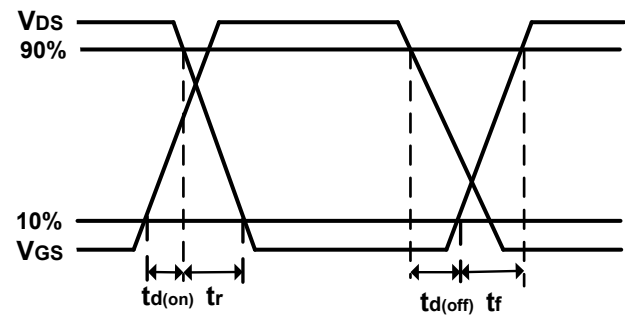
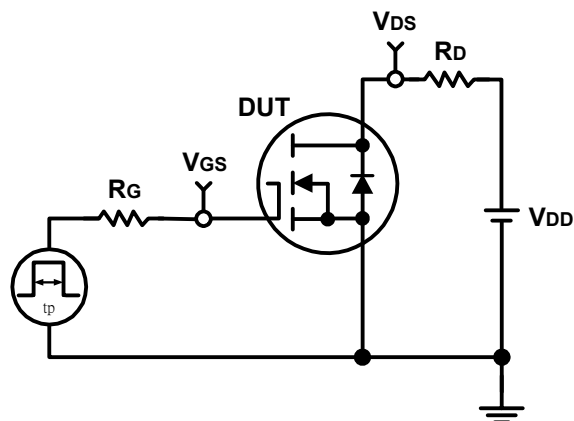
Source-Drain Diode Forward



Avalanche Test Circuit and Waveforms

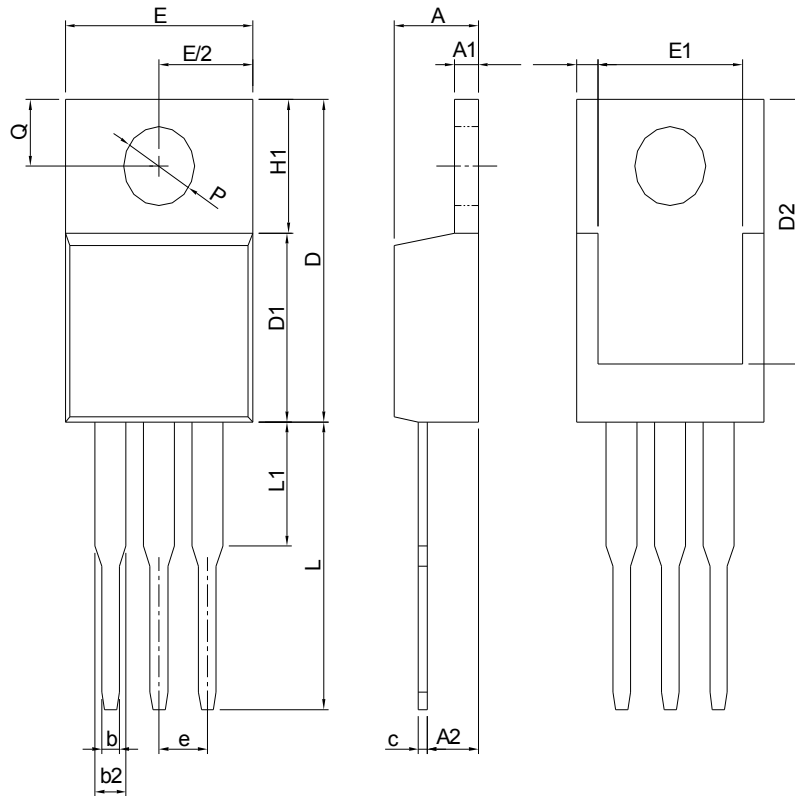


Switching Time Test Circuit and Waveforms



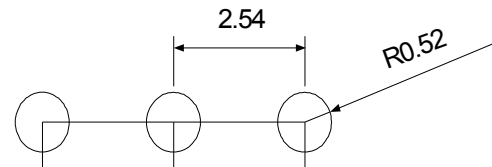
Package Information

TO-220



SYMBOL	TO-220			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	3.56	4.83	0.140	0.190
A1	0.51	1.40	0.020	0.055
A2	2.03	2.92	0.080	0.115
b	0.38	1.02	0.015	0.040
b2	1.14	1.78	0.045	0.070
c	0.36	0.61	0.014	0.024
D	14.22	16.51	0.560	0.650
D1	8.38	9.02	0.330	0.355
D2	12.19	13.65	0.480	0.537
E	9.65	10.67	0.380	0.420
E1	6.86	8.89	0.270	0.350
e	2.54 BSC		0.100 BSC	
H1	5.84	6.86	0.230	0.270
L	12.70	14.73	0.500	0.580
L1	-	6.35	-	0.250
P	3.53	4.09	0.139	0.161
Q	2.54	3.43	0.100	0.135

RECOMMENDED LAND PATTERN



UNIT: mm

Note: Follow JEDEC TO-220 AB.